

Notice Date: 03/10/2004

Product Category: A/D Converters; Linear Devices;
Serial Communication; Core 12;
Core 14; Core 16; PIC16xxx;
PIC18xxx

Notification Subject: Change #484 - 28L SPDIP at
Unisem

Notification Body:

Microchip Part # :

MCP23016
PIC16C557
PIC16C57
PIC16C57C
PIC16C62A
PIC16C72
PIC16F57
PIC16F716
PIC16F72
PIC16F73
PIC16F76
PIC16F870
PIC16F873
PIC16F876
PIC16FR57
PIC16FR62A
PIC16FR72
PIC16LC557
PIC16LC57C
PIC16LC62A
PIC16LC72
PIC16LF72

PIC16LF73
PIC16LF76
PIC16LF870
PIC16LF873
PIC16LF876
PIC16LFR62A
PIC16LFR72
PIC18C242
PIC18C252
PIC18F2331
PIC18F242
PIC18F2431
PIC18F2439
PIC18F248
PIC18F258
PIC18F2585
PIC18F2586
PIC18F2620
PIC18F2680
PIC18F2681
PIC18LC242
PIC18LC252
PIC18LF2331
PIC18LF242
PIC18LF2431
PIC18LF2439
PIC18LF248
PIC18LF258
PIC18LF2585
PIC18LF2586
PIC18LF2620
PIC18LF2680
PIC18LF2681
TC514
TC530

Description of Change:
To Qualify 28L SPDIP (.300") Package Assembly at
UNISEM, Malaysia

Impacts to Data Sheet:
NONE

Reason for Change:
Additional assembly site for capacity

Markings to Distinguish Revised From Unrevised Devices:
(e.g.: Date Code, Device Marking, Ship Container Marking)
Date and Traceability Code